

STGW50NC60W

N-channel 600V - 55A - TO-247 Ultra fast switching PowerMESH™ IGBT

Features

| Туре | V _{CES} | V _{CE(sat)} (max)@25°C | I _C @100°C |
|-------------|------------------|------------------------------------|--------------------------|
| STGW50NC60W | 600V | < 2.6V | 55A |

- Very high frequency operation
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)

Applications

- Very high frequency inverters, UPS
- HF, SMPS and PFC in both hard switch and resonant topologies
- Motor drivers
- Welding

Description

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding performances. The suffix "W" identifies a family optimized for very high frequency applications.

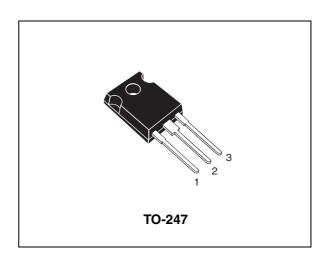


Figure 1. Internal schematic diagram

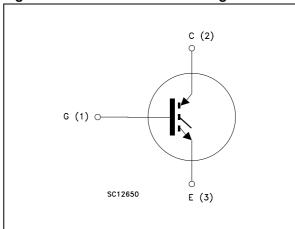


Table 1. Device summary

| Order code | Marking | Package | Packaging |
|-------------|-----------|---------|-----------|
| STGW50NC60W | GW50NC60W | TO-247 | Tube |

Contents STGW50NC60W

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STGW50NC60W Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------------------|--|------------|------|
| V _{CES} | Collector-emitter voltage (V _{GS} = 0) | 600 | V |
| I _C ⁽¹⁾ | Collector current (continuous) at T _C = 25°C | 100 | Α |
| I _C ⁽¹⁾ | Collector current (continuous) at T _C = 100°C | 55 | Α |
| I _{CL} ⁽²⁾ | Turn-off SOA minimum current | 250 | Α |
| V _{GE} | Gate-emitter voltage | ±20 | V |
| P _{TOT} | Total dissipation at T _C = 25°C | 285 | W |
| T _j | Operating junction temperature | -55 to 150 | °C |

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, \ I_{C})}$$

2. $V_{clamp} = 480V$, $T_J = 150$ °C, $R_G = 10\Omega$, $V_{GE} = 15V$

Table 2. Thermal resistance

| Symbol | Parameter | Value | Unit |
|-----------|---|-------|------|
| Rthj-case | Thermal resistance junction-case max IGBT | 0.45 | °C/W |
| Rthj-amb | Thermal resistance junction-ambient max | 50 | °C/W |

Electrical characteristics STGW50NC60W

2 Electrical characteristics

(T_{CASE} =25°C unless otherwise specified)

Table 3. Static

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|----------------------|--|--|------|------------|----------|----------|
| V _{BR(CES)} | Collector-emitter breakdown voltage | I _C = 1mA, V _{GE} = 0 | 600 | | | ٧ |
| V _{CE(sat)} | Collector-emitter saturation voltage | V _{GE} = 15V, I _C = 40A V _{GE} = 15V, I _C =40A,Tc=125°C | | 2.1 1.9 | 2.6 | V V |
| V _{GE(th)} | Gate threshold voltage | $V_{CE} = V_{GE}, I_{C} = 250 \mu A$ | 3.75 | | 5.75 | V |
| I _{CES} | Collector cut-off current (V _{GE} = 0) | V_{CE} = Max rating, T_{C} = 25°C V_{CE} = Max rating, T_{C} = 125°C | | | 500 5 | μA mA |
| I _{GES} | Gate-emitter leakage current (V _{CE} = 0) | V _{GE} = ±20V, V _{CE} = 0 | | | ±100 | nA |
| 9 _{fs} | Forward transconductance | V _{CE} = 15V _, I _C =40A | | 25 | | S |

Table 4. Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|-------------------|------|----------------|
| C _{ies} C _{oes} C _{res} | Input capacitance Output capacitance Reverse transfer capacitance | $V_{CE} = 25V, f = 1MHz,$ $V_{GE} = 0$ | | 4700 410 90 | | pF pF pF |
| Q _g Q _{ge} Q _{gc} | Total gate charge Gate-emitter charge Gate-collector charge | V_{CE} = 390V, I_{C} = 40A, V_{GE} = 15V, Figure 16 | | 195 32 82 | | nC nC nC |

Table 5. Switching on/off (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|--|--|------|------------------|------|------------------|
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | $V_{CC} = 390V, I_{C} = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V$ | | 52 17 2400 | | ns ns A/µs |
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | $V_{CC} = 390V, I_{C} = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ $Tj = 125^{\circ}C$ | | 50 19 2020 | | ns ns A/µs |
| $t_{r(Voff)} \ t_{d(Voff)} \ t_{f}$ | Off voltage rise time Turn-off delay time Current fall time | $V_{CC} = 390V, I_C = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ | | 31 240 35 | | ns ns ns |
| t _{r(Voff)} t _{d(Voff)} t _f | Off voltage rise time Turn-off delay time Current fall time | $V_{CC} = 390V, I_{C} = 40A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ $Tj = 125^{\circ}C$ | | 59 280 63 | | ns ns ns |

Table 6. Switching energy (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---|---|---|------|--------------------|--------------------|----------------|
| E _{on} E _{off} ⁽¹⁾ E _{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | V_{CC} = 390V, I_{C} = 40A R_{G} = 10 Ω V_{GE} = 15V, Figure 15 | | 365 560 925 | 470 790 1260 | րJ րJ րJ |
| E _{on} E _{off} ⁽²⁾ E _{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | V_{CC} = 390V, I_{C} = 40A R_{G} = 10 Ω , V_{GE} = 15V, T_{J} = 125°C Figure 15 | | 635 910 1545 | | μJ μJ μJ |

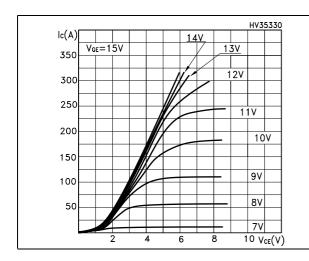
^{1.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGW50NC60W

2.1 Electrical characteristics (curves)

Figure 1. Output characteristics

Figure 2. Transfer characteristics



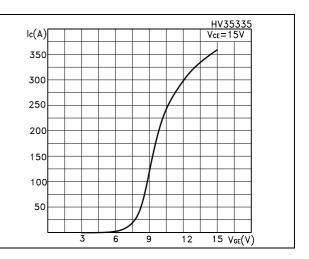
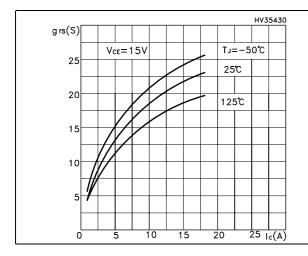


Figure 3. Transconductance

Figure 4. Collector-emitter on voltage vs temperature



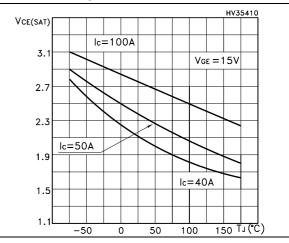


Figure 5. Gate charge vs gate-source voltage Figure 6. Capacitance variations

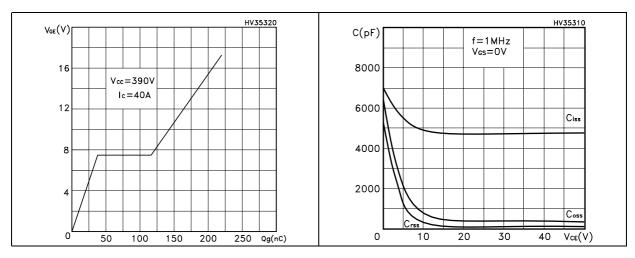


Figure 7. Normalized gate threshold voltage Figure 8. Collector-emitter on voltage vs vs temperature collector current

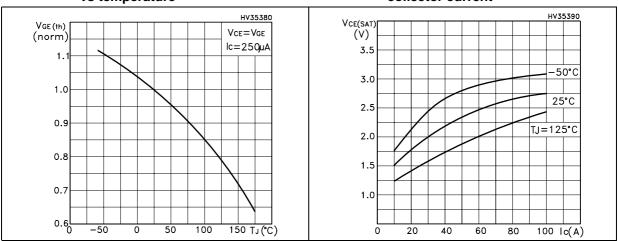
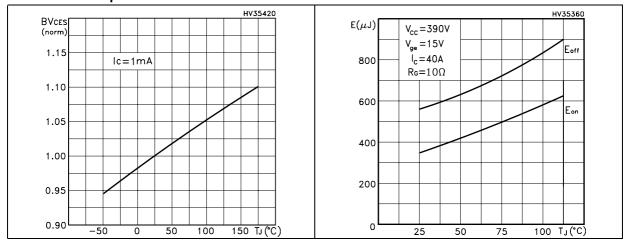


Figure 9. Normalized breakdown voltage vs Figure 10. Switching losses vs temperature temperature



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Electrical characteristics STGW50NC60W

Figure 11. Switching losses vs gate resistance Figure 12. Switching losses vs collector current

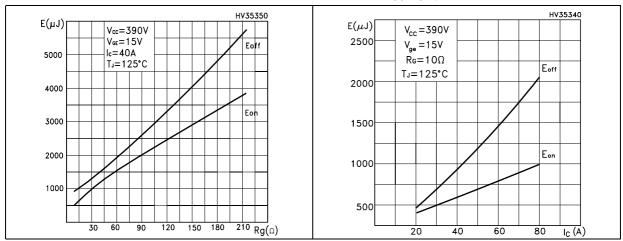
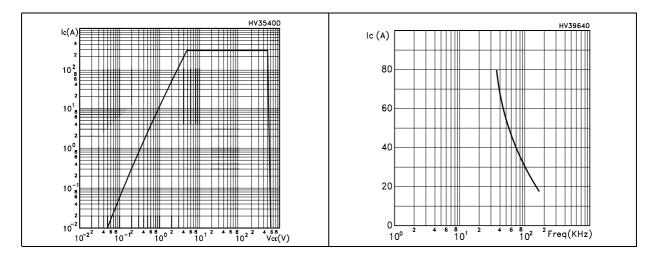


Figure 13. Turn-off SOA

Figure 14. I_C vs. frequency



2.2 Frequency applications

For a fast IGBT suitable for high frequency applications, the typical collector current vs. maximum operating frequency curve is reported. That frequency is defined as follows:

$$f_{MAX} = (P_D - P_C) / (E_{ON} + E_{OFF})$$

• The maximum power dissipation is limited by maximum junction to case thermal resistance:

Equation 1

$$P_D = \Delta T / R_{THJ-C}$$

considering
$$\Delta T = T_J - T_C = 125 \,^{\circ}\text{C} - 75 \,^{\circ}\text{C} = 50 \,^{\circ}\text{C}$$

• The conduction losses are:

Equation 2

$$P_C = I_C * V_{CE(SAT)} * \delta$$

with 50% of duty cycle, V_{CESAT} typical value @125°C.

Power dissipation during ON & OFF commutations is due to the switching frequency:

Equation 3

$$P_{SW} = (E_{ON} + E_{OFF}) * freq.$$

Typical values @ 125°C for switching losses are used (test conditions: V_{CE} = 390V, V_{GE} = 15V, R_G = 10 Ohm). Furthermore, diode recovery energy is included in the E_{ON} (see note 2), while the tail of the collector current is included in the E_{OFF} measurements (see note 3).

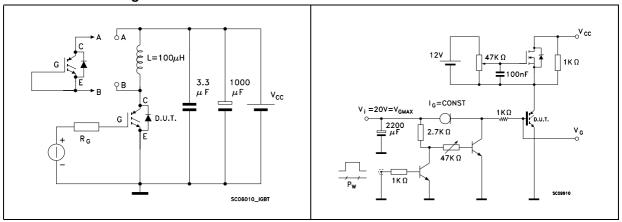
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Test circuit STGW50NC60W

3 Test circuit

Figure 15. Test circuit for inductive load switching

Figure 16. Gate charge test circuit

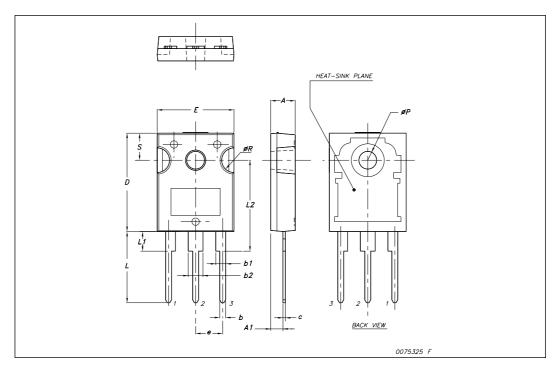


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-247 Mechanical data

| Dim. | | mm. | |
|----------|-------|-------|-------|
| D | Min. | Тур | Max. |
| Α | 4.85 | | 5.15 |
| A1 | 2.20 | | 2.60 |
| b | 1.0 | | 1.40 |
| b1 | 2.0 | | 2.40 |
| b2 | 3.0 | | 3.40 |
| С | 0.40 | | 0.80 |
| D | 19.85 | | 20.15 |
| E | 15.45 | | 15.75 |
| е | | 5.45 | |
| L | 14.20 | | 14.80 |
| L1 | 3.70 | | 4.30 |
| L2 | | 18.50 | |
| øΡ | 3.55 | | 3.65 |
| øR | 4.50 | | 5.50 |
| S | | 5.50 | |



STGW50NC60W Revision history

5 Revision history

Table 7. Document revision history

| Date | Revision | Changes |
|-------------|----------|------------------|
| 24-Aug-2007 | 1 | Initial release. |

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